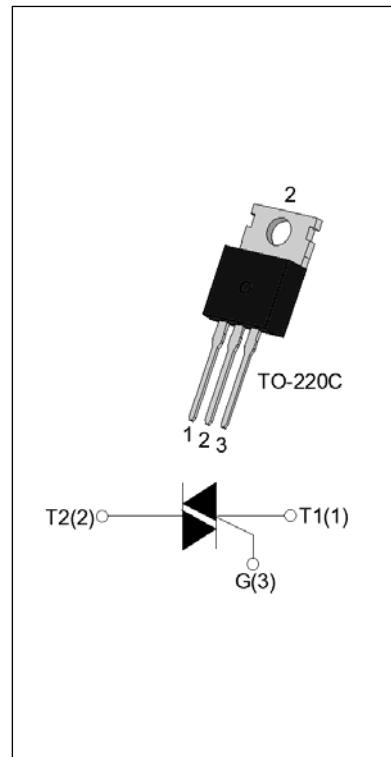


**DESCRIPTION:**

The JST30C-1200BW triac is suitable for general purpose AC switching. It can be used as an ON/OFF function in applications such as heating regulation, induction motor starting circuits, for phase control operation in light dimmers, motor speed controllers. JST30C-1200BW snubberless triac is especially recommended for use on inductive loads. From T2 terminals to external heatsink. Package TO-220C is RoHS compliant.

**MAIN FEATURES**

| Symbol                   | Value    | Unit |
|--------------------------|----------|------|
| $I_{T(RMS)}$             | 30       | A    |
| $V_{DRM}/V_{RRM}$        | 1200     | V    |
| $I_{GT\text{ I/II/III}}$ | 50/50/50 | mA   |

**ABSOLUTE MAXIMUM RATINGS**

| Parameter  | Symbol       | Value   | Unit                   |
|--|--------------|---------|------------------------|
| Storage junction temperature range   | $T_{stg}$    | -40-150 | °C                     |
| Operating junction temperature range   | $T_j$        | -40-125 | °C                     |
| Repetitive peak off-state voltage ( $T_j=25^\circ\text{C}$ )   | $V_{DRM}$    | 1200    | V                      |
| Repetitive peak reverse voltage ( $T_j=25^\circ\text{C}$ )   | $V_{RRM}$    | 1200    | V                      |
| RMS on-state current ( $T_c \leq 100^\circ\text{C}$ )  | $I_{T(RMS)}$ | 30      | A                      |
| Non repetitive surge peak on-state current (full cycle , $t_p=20\text{ms}$ , $T_j=25^\circ\text{C}$ )            | $I_{TSM}$    | 300     | A                      |
| Non repetitive surge peak on-state current (full cycle , $t_p=16.6\text{ms}$ , $T_j=25^\circ\text{C}$ )          |              | 330     |                        |
| $I^2t$ value for fusing ( $t_p=10\text{ms}$ , $T_j=25^\circ\text{C}$ )   | $I^2t$       | 450     | $\text{A}^2\text{s}$   |
| Critical rate of rise of on-state current ( $I_G=2 \times I_{GT}$ , $f=100\text{Hz}$ , $T_j=125^\circ\text{C}$ ) | $di/dt$      | 100     | $\text{A}/\mu\text{s}$ |
| Peak gate current ( $t_p=20\mu\text{s}$ , $T_j=125^\circ\text{C}$ )  | $I_{GM}$     | 4       | A                      |
| Average gate power dissipation ( $T_j=125^\circ\text{C}$ )   | $P_{G(AV)}$  | 0.5     | W                      |
| Peak gate power  | $P_{GM}$     | 10      | W                      |

|  |                 |     |    |
|--|-----------------|-----|----|
| Peak pulse voltage<br>(T <sub>j</sub> =25°C; non-repetitive,off-state;FIG.7) | V <sub>pp</sub> | 2.5 | kV |
|--|-----------------|-----|----|

**ELECTRICAL CHARACTERISTICS** (T<sub>j</sub>=25°C unless otherwise specified)

| Symbol           | Test Condition  | Quadrant    | Value |      | Unit |
|------------------|---|-------------|-------|------|------|
| I <sub>GT</sub>  | V <sub>D</sub> =12V R <sub>L</sub> =33Ω   | I - II -III | MAX.  | 50   | mA   |
| V <sub>GT</sub>  |   | I - II -III | MAX.  | 1.3  | V    |
| V <sub>GD</sub>  | V <sub>D</sub> =V <sub>DRM</sub> T <sub>j</sub> =125°C<br>R <sub>L</sub> =3.3KΩ         | I - II -III | MIN.  | 0.15 | V    |
| I <sub>L</sub>   | I <sub>G</sub> =1.2I <sub>GT</sub>  | I - III     | MAX.  | 90   | mA   |
|                  |   | II          |       | 100  |      |
| I <sub>H</sub>   | I <sub>T</sub> =500mA   |             | MAX.  | 80   | mA   |
| dV/dt            | V <sub>D</sub> =800V Gate Open T <sub>j</sub> =125°C                                    |             | MIN.  | 1200 | V/μs |
| (dI/dt)c         | (dV/dt)c=20V/μs T <sub>j</sub> =125°C   |             | MIN.  | 25   | A/ms |
| t <sub>on</sub>  | I <sub>G</sub> =80mA I <sub>A</sub> =400mA I <sub>R</sub> =40mA<br>T <sub>j</sub> =25°C | TYP.        | 10    | μs   |      |
| t <sub>off</sub> |   |             | 70    |      |      |

**STATIC CHARACTERISTICS**

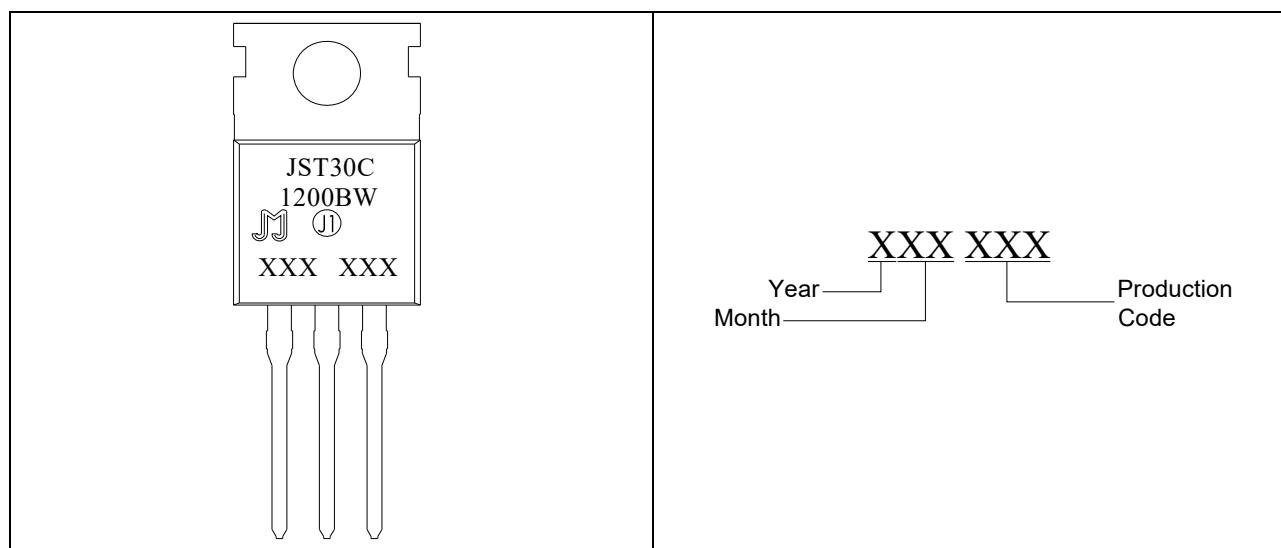
| Symbol           | Parameter   |                       | Value(MAX.) | Unit |
|------------------|---|-----------------------|-------------|------|
| V <sub>TM</sub>  | I <sub>TM</sub> =42A t <sub>p</sub> =380μs                        | T <sub>j</sub> =25°C  | 1.5         | V    |
| V <sub>TO</sub>  | Threshold voltage   | T <sub>j</sub> =125°C | 0.73        | V    |
| R <sub>D</sub>   | Dynamic resistance  | T <sub>j</sub> =125°C | 25          | mΩ   |
| I <sub>DRM</sub> | V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub> | T <sub>j</sub> =25°C  | 10          | μA   |
| I <sub>RRM</sub> |   | T <sub>j</sub> =125°C | 4           | mA   |

**THERMAL RESISTANCES**

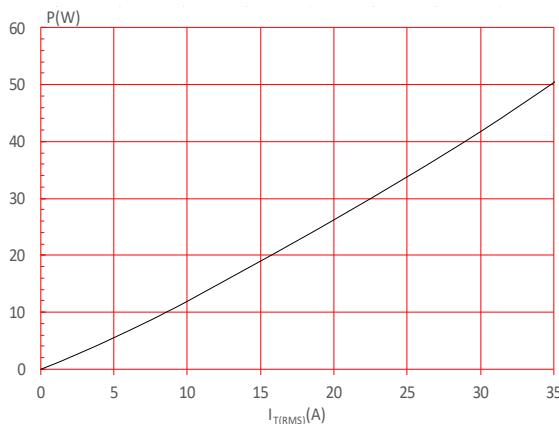
| Symbol               | Parameter                | Value | Unit |
|----------------------|--------------------------|-------|------|
| R <sub>th(j-c)</sub> | junction to case (AC)    | 0.6   | °C/W |
| R <sub>th(j-a)</sub> | junction to ambient (AC) | 60    | °C/W |

**ORDERING INFORMATION**

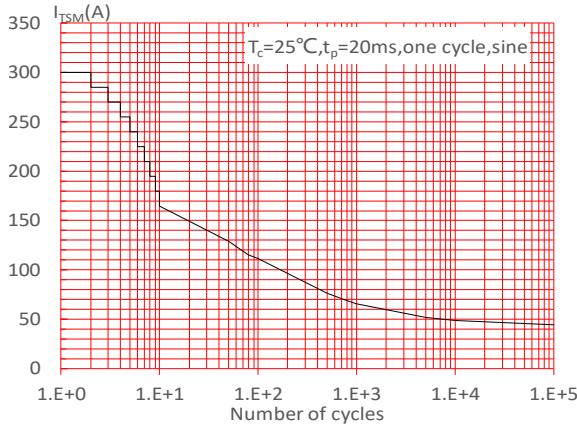
|                                   |           |                               |                  |   |                                    |
|-----------------------------------|-----------|-------------------------------|------------------|---|------------------------------------|
| <u>J</u>                          | <u>ST</u> | <u>30</u>                     | <u>C</u>         | <u>-1200</u>                                      | <u>BW</u>                          |
| JieJie Microelectronics Co., Ltd. |           |                               |                  |   |                                    |
|                                   | Triacs    |                               |                  |   |                                    |
|                                   |           | <u>I<sub>T(RMS)</sub>:30A</u> |                  |   |                                    |
|                                   |           |                               | <u>C:TO-220C</u> |   | <u>BW:I<sub>G(T1-3)</sub>≤50mA</u> |
|                                   |           |                               |                  | <u>1200:V<sub>DRM</sub>/V<sub>RRM</sub>≥1200V</u> |                                    |

**MARKING**

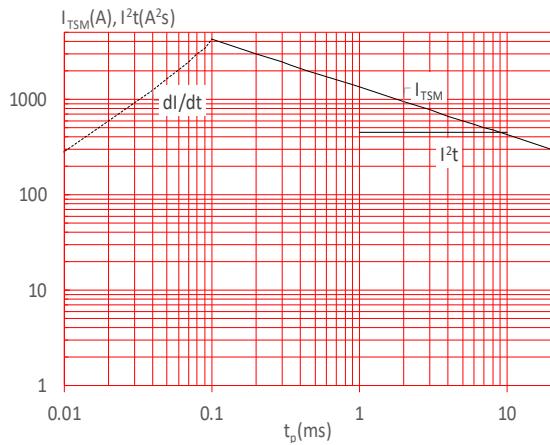
**FIG.1** Maximum power dissipation versus RMS on-state current



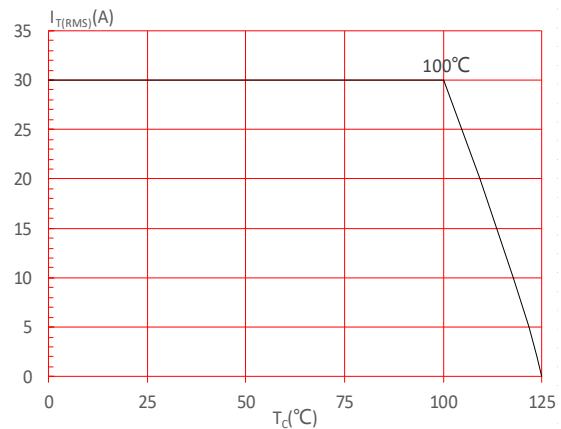
**FIG.3:** Surge peak on-state current versus number of cycles



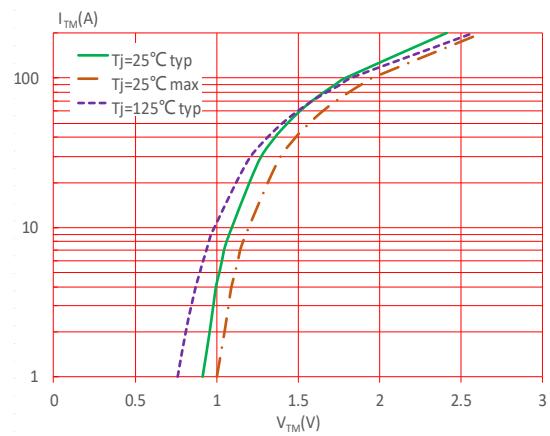
**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 20\text{ms}$ , and corresponding value of  $I^2t$  ( $\text{d}I/\text{d}t < 100\text{A}/\mu\text{s}$ )



**FIG.2:** RMS on-state current versus case temperature



**FIG.4:** On-state characteristics



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature

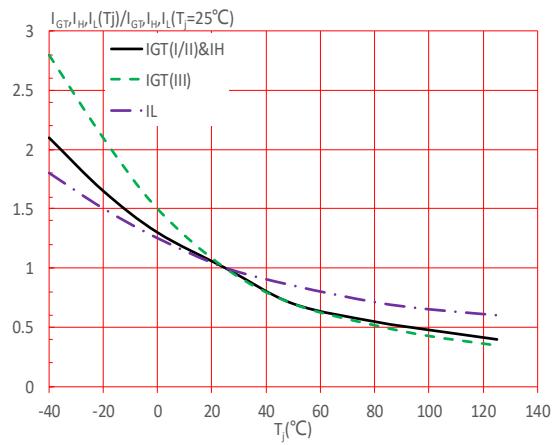
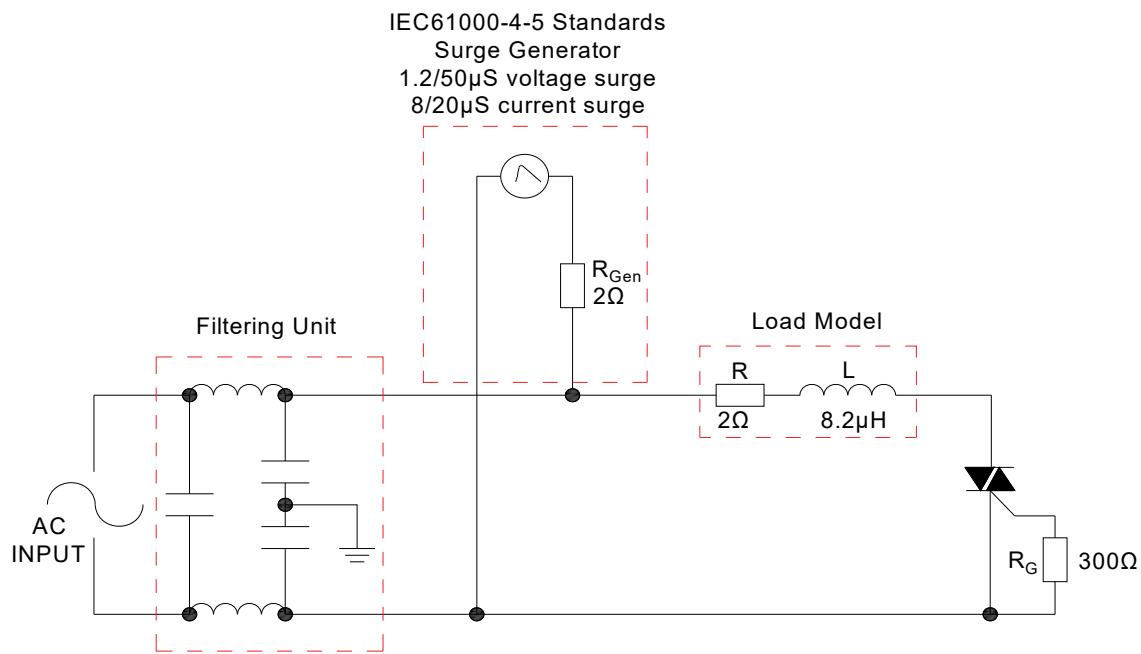


FIG.7: Test circuit for inductive and resistive loads to IEC-61000-4-5 standards



## SHAPING AND SOLDERING PARAMETERS

Refer to 《Instructions for installation of plastic-sealed in-line power devices》 released by JieJie

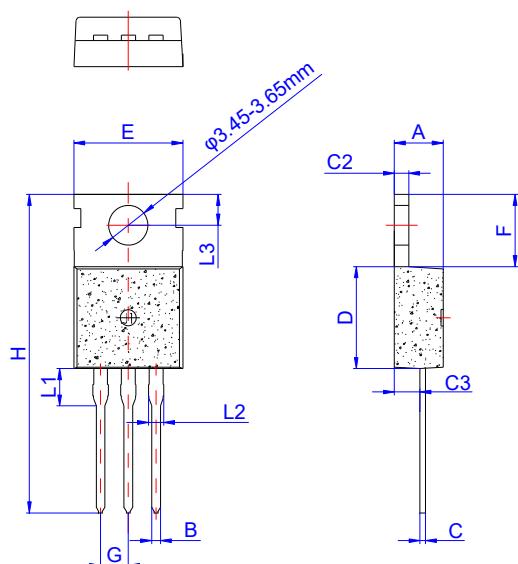
**ORDERING INFORMATION**

| Order code           | Voltage<br>$V_{DRM}/V_{RRM}$ (V) | IGT(mA)   | Package        | Base qty.<br>(pcs) | Delivery mode |
|----------------------|----------------------------------|-----------|----------------|--------------------|---------------|
|                      |                                  | I -II-III |                |                    |               |
| <b>JST30C-1200BW</b> | <b>1200</b>                      | <b>50</b> | <b>TO-220C</b> | <b>50</b>          | <b>Tube</b>   |

**Document Revision History**

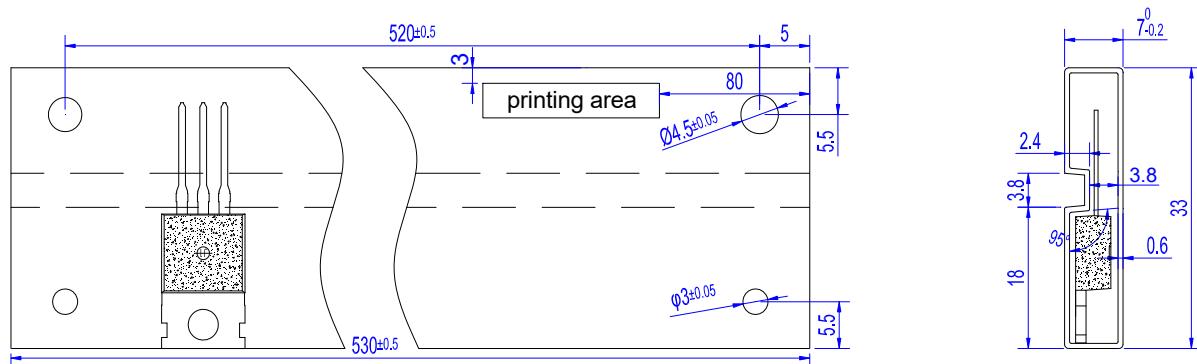
| Date         | Revision | Changes      |
|--------------|----------|--------------|
| Apr.11, 2023 | A.1.0    | Last updated |

## PACKAGE MECHANICAL DATA



| Ref. | Dimensions  |      |      |        |      |       |
|------|-------------|------|------|--------|------|-------|
|      | Millimeters |      |      | Inches |      |       |
|      | Min.        | Typ. | Max. | Min.   | Typ. | Max.  |
| A    | 4.40        |      | 4.60 | 0.173  |      | 0.181 |
| B    | 0.70        |      | 0.90 | 0.028  |      | 0.035 |
| C    | 0.45        |      | 0.60 | 0.018  |      | 0.024 |
| C2   | 1.25        |      | 1.35 | 0.049  |      | 0.053 |
| C3   | 2.20        |      | 2.60 | 0.087  |      | 0.102 |
| D    | 8.90        |      | 9.90 | 0.350  |      | 0.390 |
| E    | 9.90        |      | 10.3 | 0.390  |      | 0.406 |
| F    | 6.30        |      | 6.90 | 0.248  |      | 0.272 |
| G    | 2.40        |      | 2.70 | 0.094  |      | 0.106 |
| H    | 28.0        |      | 29.8 | 1.102  |      | 1.173 |
| L1   | 2.70        |      | 3.30 | 0.106  |      | 0.130 |
| L2   | 1.14        |      | 1.70 | 0.045  |      | 0.067 |
| L3   | 2.65        |      | 2.95 | 0.104  |      | 0.116 |

## DELIVERY MODE



| PACKAGE | OUTLINE | TUBE<br>(PCS) | INNER BOX<br>(PCS) | PER CARTON |
|---------|---------|---------------|--------------------|------------|
| TO-220C | TUBE    | 50            | 1,000              | 5,000      |

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